

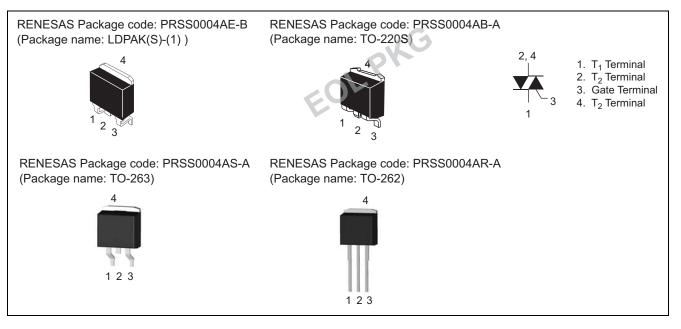
BCR10CS-12LB

600V-10A-Triac Medium Power Use

Features

- I_{T (RMS)} : 10 A
- V_{DRM} : 600 V
- I_{FGTI}, I_{RGTI}, I_{RGT III}: 30 mA (20 mA)^{Note6}
- The product guaranteed maximum junction temperature of 150°C
- Non-Insulated Type
- Planar Passivation Type

Outline



Applications

Contactless AC switch, light dimmer, electronic flasher unit, control of household equipment such as TV sets, stereo systems, refrigerator, washing machine, infrared kotatsu, carpet, electric fan, solenoid driver, small motor control, solid state relay, copying machine, electric tool, electric heater control, and other general purpose control applications

Maximum Ratings

Parameter	Symbol	Voltage class 12	Unit
Repetitive peak off-state voltage ^{Note1}	Vdrm	600	V
Non-repetitive peak off-state voltageNote1	V _{DSM}	720	V

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RENESAS

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Parameter	Symbol	Ratings	Unit	Conditions
RMS on-state current	I _{T (RMS)}	10	A	Commercial frequency, sine full wave 360° conduction, Tc = $128^{\circ}C^{Note3}$
Surge on-state current	Ітѕм	100	A	60Hz sinewave 1 full cycle, peak value, non-repetitive
I ² t for fusing	l ² t	41.6	A ² s	Value corresponding to 1 cycle of half wave 60Hz, surge on-state current
Peak gate power dissipation	P _{GM}	5	W	
Average gate power dissipation	P _{G (AV)}	0.5	W	
Peak gate voltage	V_{GM}	10	V	
Peak gate current	I _{GM}	2	А	
Junction temperature	Tj	- 40 to +150	°C	
Storage temperature	Tstg	- 40 to +150	°C	
Mass	_	1.3	g	Typical value

Notes: 1. Gate open.

Electrical Characteristics

Parameter		Symbol	Min.	Тур.	Max.	Unit	Test conditions
Repetitive peak off-state cur	rent	I _{DRM}	—	_	2.0	mA	Tj = 150°C, V _{DRM} applied
On-state voltage		V _{TM}	—		1.5	V	Tc = 25° C, I _{TM} = 15 A, Instantaneous measurement
Gate trigger voltage ^{Note2}	Ι	V_{FGTI}	—	_	1.5	V	$\label{eq:Tj} \begin{array}{l} Tj=25^{\circ}C, \ V_{D}=6 \ V, \ R_{L}=6 \ \Omega, \\ R_{G}=330 \ \Omega \end{array}$
	II	V_{RGTI}	—	_	1.5	V	
	III	V _{RGTIII}	—	_	1.5	V	
Gate trigger currentNote2	Ι	IFGTI	_		30 ^{Note6}	mA	$\label{eq:TJ} \begin{split} Tj &= 25^\circ C, \ V_D = 6 \ V, \ R_L = 6 \ \Omega, \\ R_G &= 330 \ \Omega \end{split}$
	II	Irgti	—	_	30 ^{Note6}	mA	
	III	Irgtiii	—	_	30 ^{Note6}	mA	
Gate non-trigger voltage		V_{GD}	0.2/0.1		—	V	$Tj = 125^{\circ}C/150^{\circ}C, V_D = 1/2 V_{DRM}$
Thermal resistance		Rth (j-c)	_	_	1.8	°C/W	Junction to case ^{Note3 Note4}
Critical-rate of rise of off-stat commutating voltage ^{Note5}	е	(dv/dt)c	10/1	—	—	V/µs	Tj = 125°C/150°C

Notes: 2. Measurement using the gate trigger characteristics measurement circuit.

3. Case temperature is measured on the T_2 tab.

4. The contact thermal resistance $R_{th (c-f)}$ in case of greasing is 1.0°C/W.

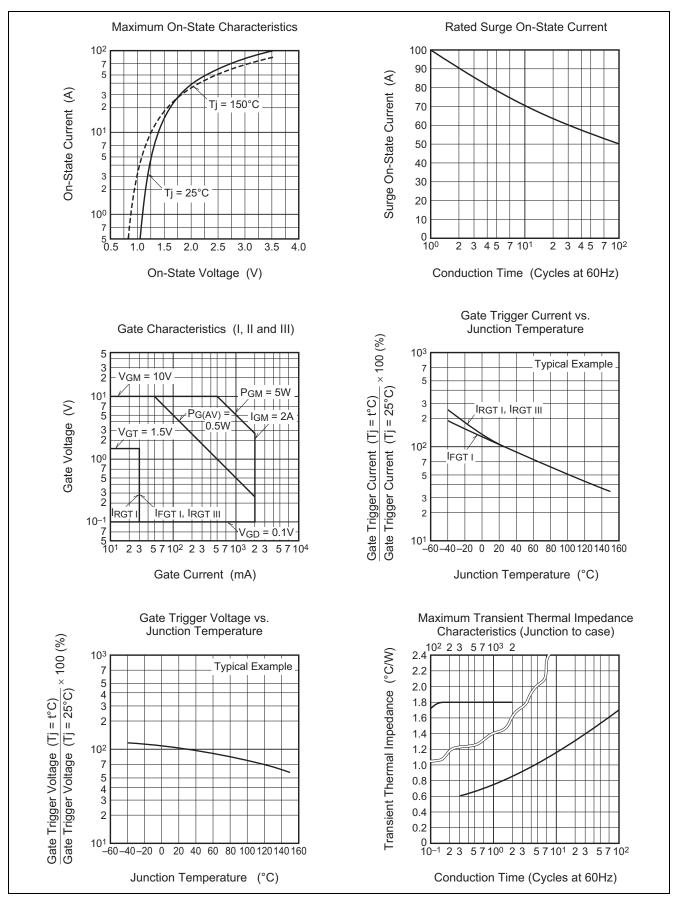
5. Test conditions of the critical-rate of rise of off-state commutating voltage is shown in the table below.

6. High sensitivity (I_{GT} \leq 20 mA) is also available. (I_{GT} item: 1)

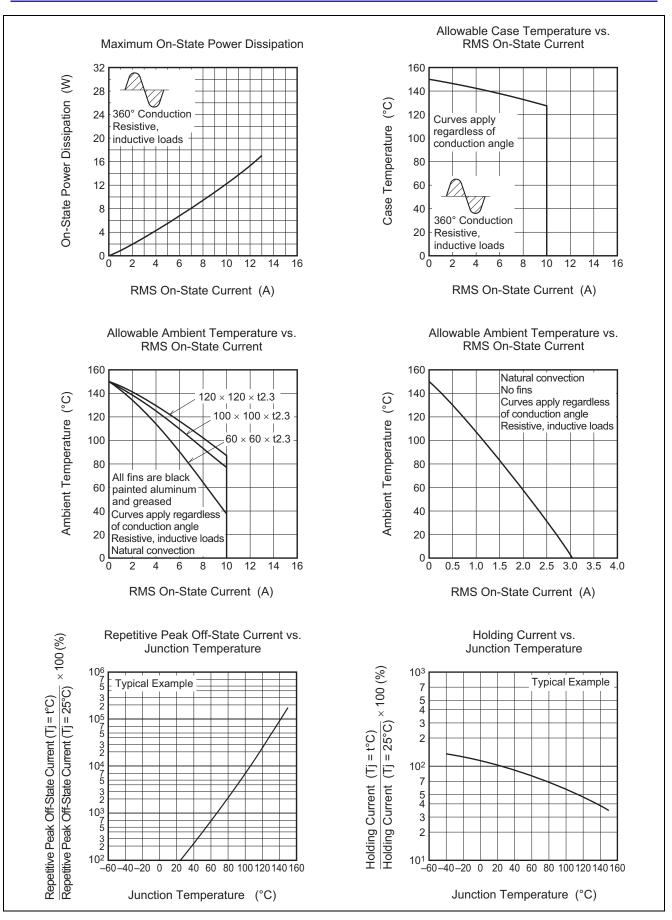
Test conditions	Commutating voltage and current waveforms (inductive load)
1. Junction temperature Tj = 125°C/150°C	Supply Voltage Time
 Rate of decay of on-state commutating current (di/dt)c = - 5.0 A/ms 	Main Current → Time
3. Peak off-state voltage V _D = 400 V	Main VoltageTime (dv/dt)c V _D

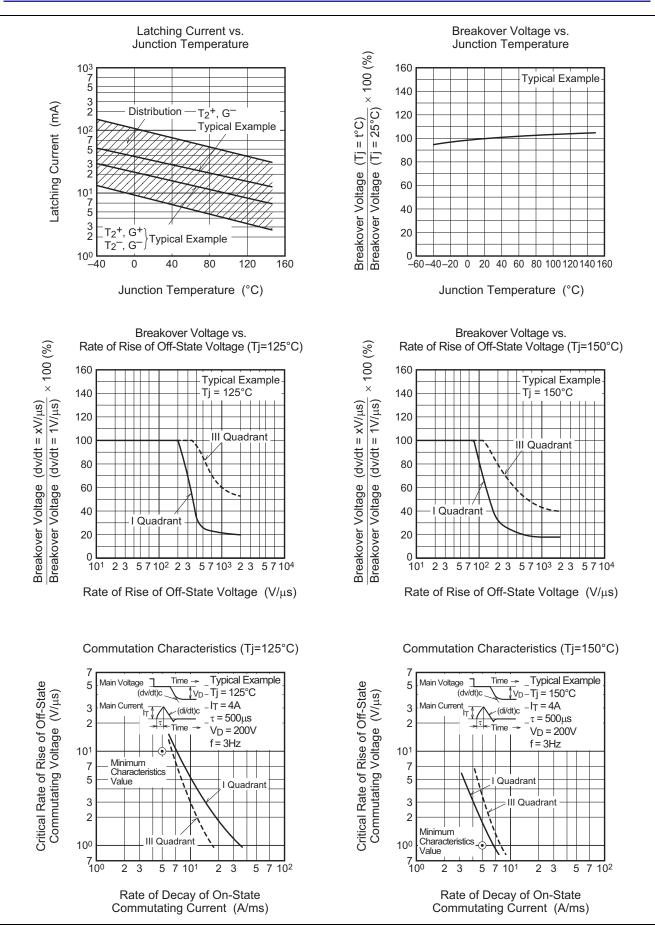


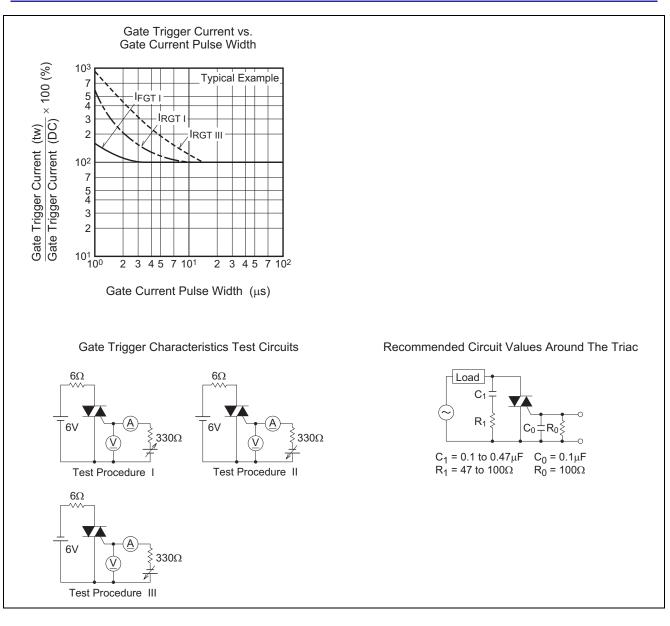
Performance Curves





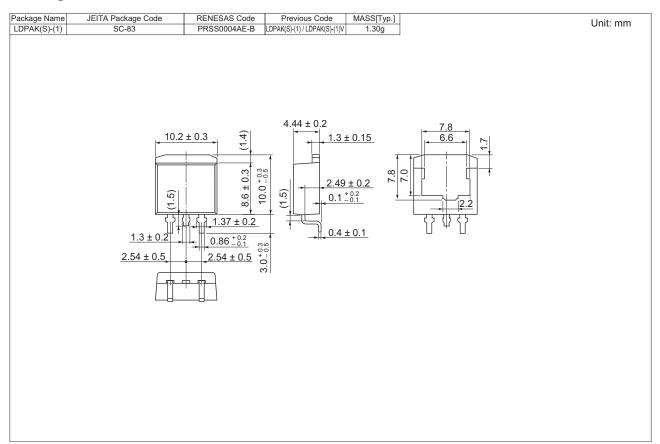


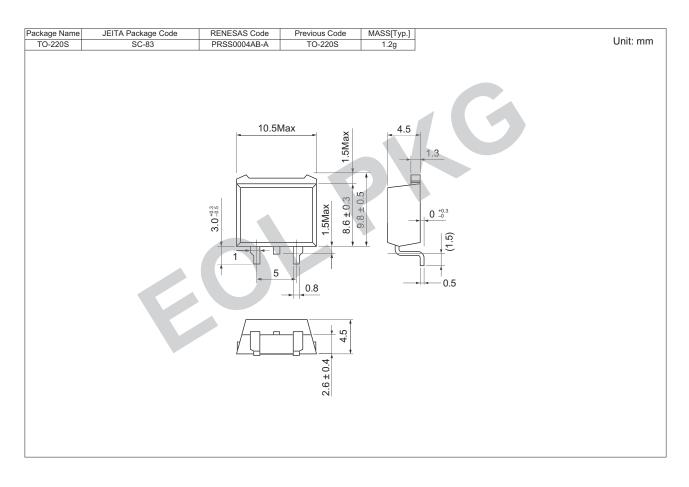






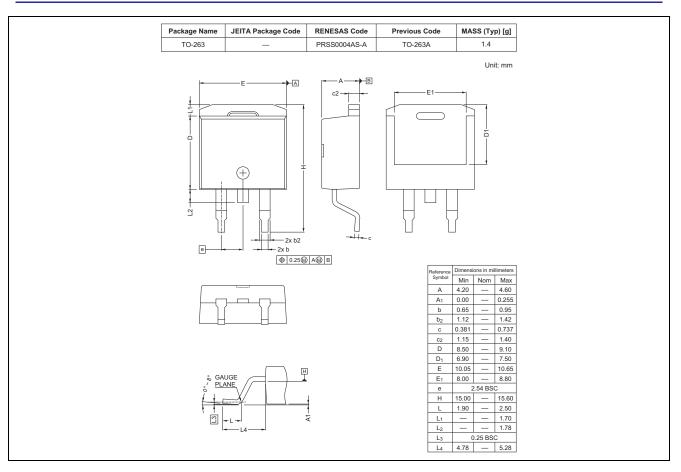
Package Dimensions

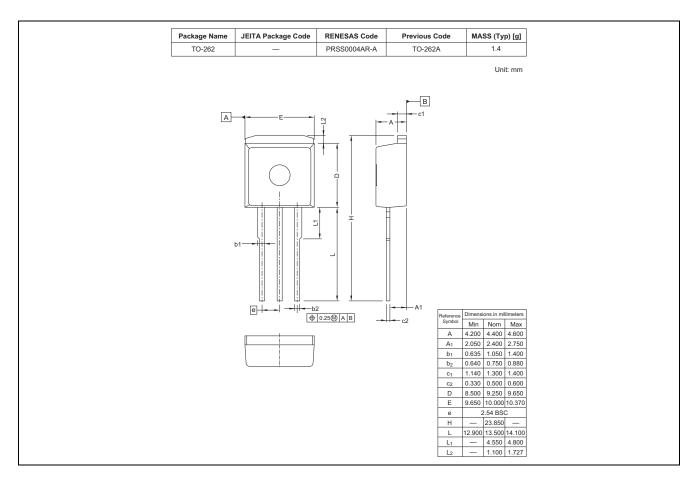






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R07DS0224EJ0500 Rev.5.00 Oct 19, 2015



Ordering Information

Orderable Part Number	Package	Packing	Quantity	Remark
BCR10CS-12LB#BH0	TO-263	Tube	50 pcs.	
BCR10CS-12LBT1#BH0	TO-263	Embossed Tape	800 pcs.	Taping direction "T1"
BCR10CS-12LBA1#BH0	TO-262	Tube	50 pcs.	
BCR10CS-12LB#B00	LDPAK(S)-(1)	Tube	50 pcs.	Not Recommend for New Design
BCR10CS12LBT11#B00	LDPAK(S)-(1)	Embossed Tape	1000 pcs.	Not Recommend for New Design
BCR10CS-12LB#B01	TO-220S	Tube	50 pcs.	EOL
BCR10CS12LBT11#B01	TO-220S	Embossed Tape	1000 pcs.	EOL

Note : Please confirm the specification about the shipping in detail.



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